

STPS200170TV1Y

Automotive high voltage power Schottky rectifier

Features

- Negligible switching losses
- Avalanche rated
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Insulated package: ISOTOP
 - Electrical insulation = 2500 V rms, capacitance = 45 pF
- AEC-Q101 qualified

Description

This high voltage Schottky rectifier is suited for high frequency switch mode power supplies.

Packaged in ISOTOP, this device is intended for use in the secondary rectification of applications.

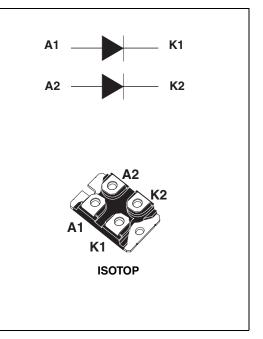


Table 1.Device summary

I _{F(AV)}	2 x 100 A
V _{RRM}	170 V
Тј	150 °C
V _F (typ)	0.63 V

Characteristics 1

Table 2.	Absolute ratings - limiting values per diode at T _{amb} = 25 °C, unless otherwise specified

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse voltage			170	V
I _{F(RMS)}	Forward rms current	Forward rms current			А
I _{F(AV)}	Average forward current, $\delta = 0.5$ T _c = 105 °C per diode		$T_c = 105 \ ^\circ C$ per diode	100	А
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			700	А
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s, T_j = 25 \ ^{\circ}C$			100000	W
T _{stg}	Storage temperature range			-55 to +150	°C
Тj	Operating junction temperature range ⁽¹⁾			-40 to +150	°C

1 condition to avoid thermal runaway for a diode on its own heatsink

1.

$\frac{\frac{dP_{tot}}{dT_{j}} < \frac{1}{R_{th(j-a)}}}{Therr}$ Table 3. Thermal parameters

Symbol	Parameter		Value	Unit
P	Junction to case Per diode Total	Per diode	0.52	
R _{th(j-c)}		0.31	°C/W	
R _{th(c)}	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $T_{j(diode1)} = P_{(diode1)} X R_{th(j-c)} (per diode) + P_{(diode2)} X R_{th(c)}$

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _B ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V - V	-	-	200	μA
'R'	R [*]	T _j = 125 °C	$V_{R} = V_{RRM}$	-	30	100	mA
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 100 A	-	-	0.85	
V ⁽²⁾		T _j = 150 °C	F = 100 A	-	0.63	0.68	v
VF TOW		T _j = 25 °C	I _F = 200 A	-	-	1.01	v
		T _j = 150 °C		-	0.78	0.86	

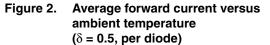
1. Pulse test: t_p = 5 ms, δ < 2 %

2. Pulse test: t_p = 380 µs, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.5 x $I_{F(AV)}$ + 0.0018 ${I_F}^2_{(RMS)}$



Figure 1. Conduction losses versus average F current (per diode)



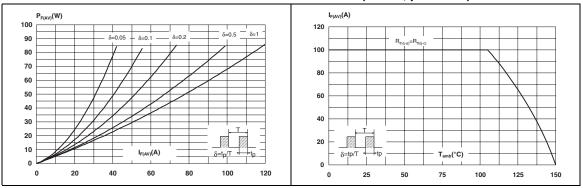


Figure 3. Non-repetitive surge peak forward current vesus overload duration (maximum values per diode)

Figure 4. Relative variation of thermal impedance (junction to case) versus pulse duration

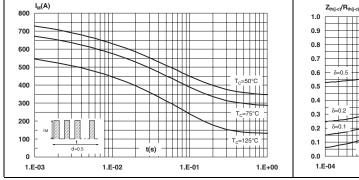


Figure 5. Reverse leakage current versus reverse voltage applied (typical values per diode)

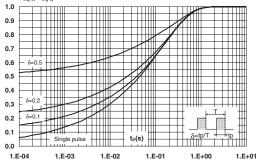
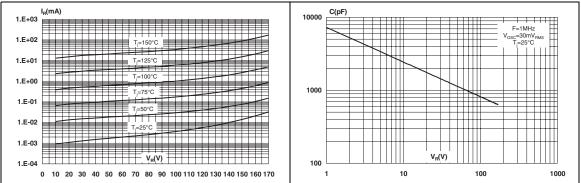


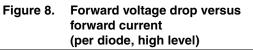
Figure 6. Junction capacitances versus reverse voltage applied (typical values per diode)



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Figure 7. Forward voltage drop versus forward current (per diode, low level)



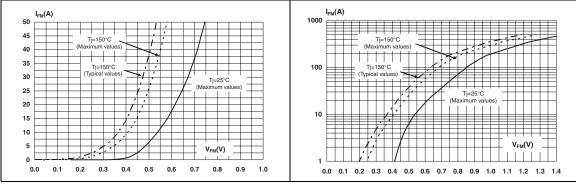
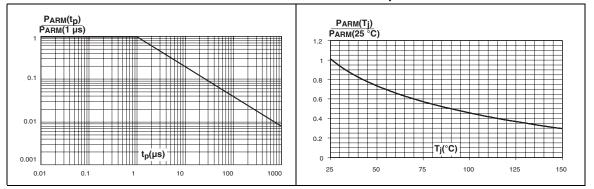


Figure 9. Normalized avalanche power derating versus pulse duration

Figure 10. Normalized avalanche power derating versus junction temperature



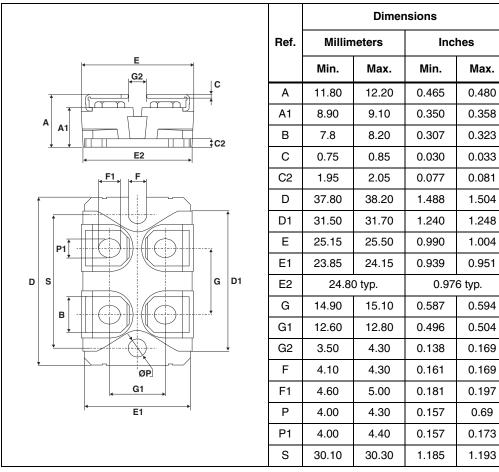


2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. ISOTOP dimensions





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3 Ordering information

Table 6.Ordering information

Order code	Marking	Package	Weight	Base qty ⁽¹⁾	Delivery mode
STPS200170TV1Y	STPS200170TV1Y	ISOTOP	27 g without screws	10 with screws	Tube

1. This product is supplied with 40 terminal screws and washers for each tube. The screws and washers are supplied in a separate pack with the order.

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
11-Mar-2010	1	First issue.



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